

### Thyristor / Diode Modules

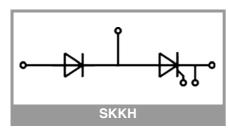
### SKKH 107/16 E

### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- UL recognized, file no. E63532

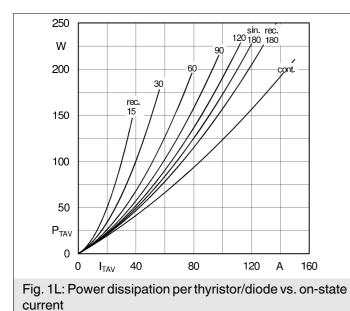
### **Typical Applications\***

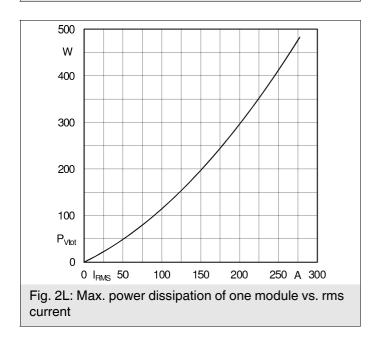
- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

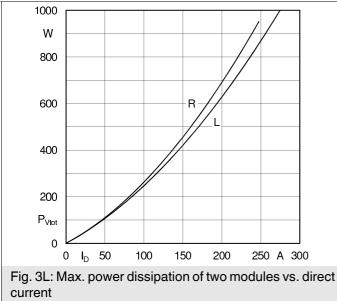


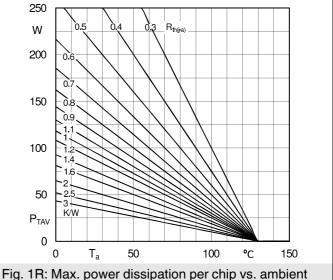
Absolute	Maximum Rating	S			
Symbol	Conditions		Values	Unit	
Chip					
I <sub>T(AV)</sub>	sinus 180°	T <sub>c</sub> = 85 °C	119	А	
		T <sub>c</sub> = 100 °C	91	А	
I <sub>TRMS</sub>	continuous operation		190	А	
I <sub>TSM</sub>	10 ms	T <sub>j</sub> = 25 °C	2250	А	
		T <sub>j</sub> = 130 °C	1900	А	
i <sup>2</sup> t	- 10 ms	T <sub>j</sub> = 25 °C	25313	A <sup>2</sup> s	
		T <sub>j</sub> = 130 °C	18050	A <sup>2</sup> s	
V <sub>RSM</sub>			1700		
V <sub>RRM</sub>			1600	V	
V <sub>DRM</sub>			1600	V	
(di/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		140	A/µs	
(dv/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C		1000	V/µs	
Tj			-40 130		
Module	·				
T <sub>stg</sub>			-40 125	°C	
V <sub>isol</sub>	a.c.; 50 Hz; r.m.s.	1 min 3000		V	
	a.u., 50 mz, 1.111.S.	1 s	3600	V	

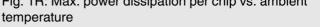
Characteristics									
Symbol	Conditions	min.	typ.	max.	Unit				
Chip	•								
V <sub>T</sub>	T <sub>j</sub> = 25 °C, I <sub>T</sub> = 300 A			1.6	1.75	V			
V <sub>T(TO)</sub>	T <sub>j</sub> = 130 °C			0.8	0.9	V			
r <sub>T</sub>	$T_j = 130 \ ^{\circ}C$			2.80	3.35	mΩ			
I <sub>DD</sub> ;I <sub>RD</sub>	$T_j = 130 \text{ °C}, V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$				20	mA			
t <sub>gd</sub>	$T_j = 25 \text{ °C}, I_G = 1 \text{ A}, di_G/dt = 1 \text{ A}/\mu s$			1		μs			
t <sub>gr</sub>	$V_{D} = 0.67 * V_{DRM}$			2		μs			
t <sub>q</sub>	T <sub>j</sub> = 130 °C			200		μs			
I <sub>H</sub>	$T_j = 25 \ ^{\circ}C$			150	250	mA			
ΙL	$T_j = 25 \ ^\circ C$ , $R_G = 33 \ \Omega$			300	600	mA			
V <sub>GT</sub>	$T_{j} = 25 \ ^{\circ}C, \ d.c.$		2.5			V			
I <sub>GT</sub>	$T_{j} = 25 \ ^{\circ}C, \ d.c.$		100			mA			
$V_{GD}$	$T_{j} = 130 \ ^{\circ}C, \ d.c.$				0.25	V			
I <sub>GD</sub>	$T_j = 130 \ ^{\circ}C, \ d.c.$				4	mA			
R <sub>th(j-c)</sub>	continuous DC	per chip			0.19	K/W			
		per module			0.095	K/W			
R <sub>th(j-c)</sub>	_sin. 180°	per chip			0.2	K/W			
		per module			0.1	K/W			
R <sub>th(j-c)</sub>	– rec. 120°	per chip			0.21	K/W			
		per module			0.105	K/W			
Module									
R <sub>th(c-s)</sub>	chip			0.22		K/W			
	module			0.11		K/W			
Ms	to heatsink M5		4.25		5.75	Nm			
Mt	to terminals M5		2.55		3.45	Nm			
a					5 * 9,81	m/s²			
W				75		g			

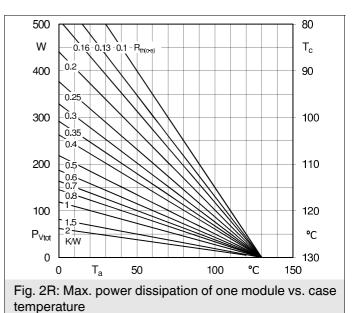












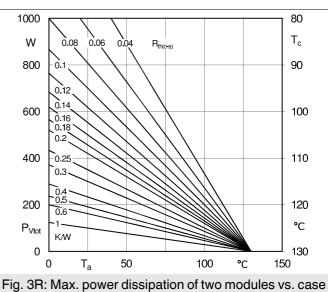
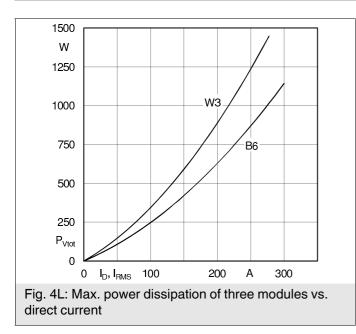
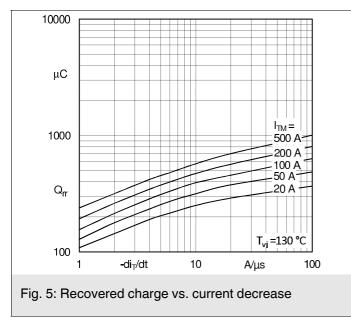
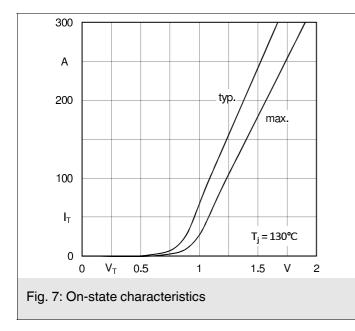


Fig. 3R: Max. power dissipation of two modules vs. case temperature







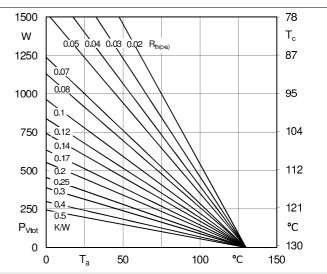
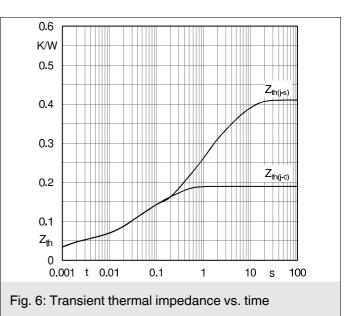


Fig. 4R: Max. power dissipation of three modules vs. case temperature



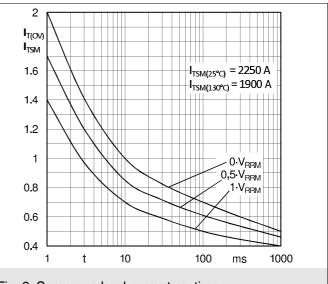
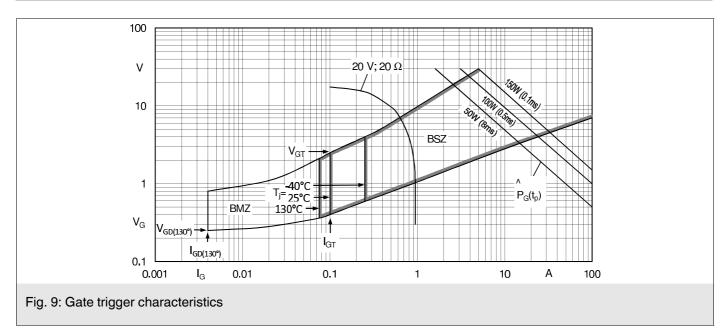
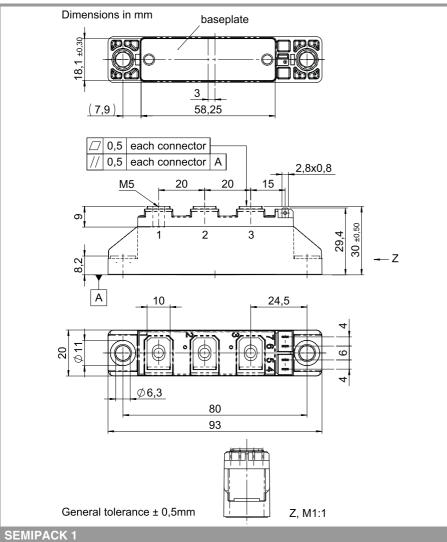
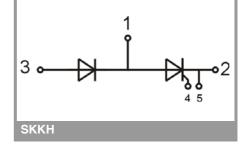


Fig. 8: Surge overload current vs. time







This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

### **\*IMPORTANT INFORMATION AND WARNINGS**

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